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SZABO et al.(10) **Pub. No.: US 2024/0215213 A1**(43) **Pub. Date: Jun. 27, 2024**(54) **STRUCTURE FOR ELECTROMAGNETIC
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(57)

ABSTRACT

Disclosed are apparatuses and techniques for fabricating apparatuses used as test platforms and commercial devices. In an aspect, an apparatus includes a non-conductive frame and a first shield structure. The first shield structure is part of the non-conductive frame. The first shield structure includes a first laser-activated surface structure, a first base metal disposed on the first laser-activated surface structure, and a first plating metal disposed on the first base metal.

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